2268945

312

2370

1329

1

1

L6

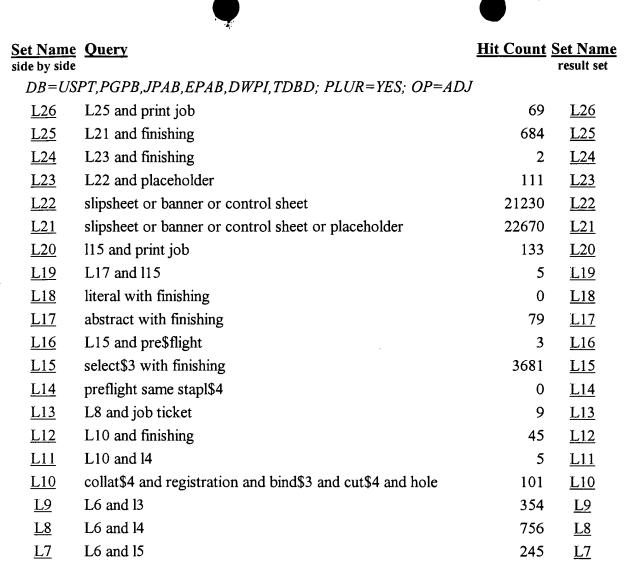
<u>L5</u>

<u>L4</u>

<u>L3</u>

<u>L2</u>

L1



**END OF SEARCH HISTORY** 

(alternat\$4 or substitu\$5)

pre\$flight\$3 same finishing

pre\$flight\$3 with finishing

finishing and user (profile or preference)

finishing same (profile or preference)

finishing with (profile or preference)

<u>L6</u>

<u>L5</u>

<u>L4</u>

<u>L3</u>

<u>L2</u>

<u>L1</u>



IEEE HOME : SEARCH IEEE : SHOP ( WEB ACCOUNT ) CONTACT IEEE



Kembership Public	cations/Services Standards Conferences	Careers/Joba		
JEE	Xplore	Welcome United States Patent and Trade	mark Office	
Help FAQ Term Peer Review	35 IEEE Quick Links	T	» Search Results	
Victoria de la composição				
O- Home	Your search matched 82 of 937782	documents.		
O-What Can I Access?	Access? A maximum of 82 results are displayed, 15 to a page, sorted by <b>Relevance</b> in			
O- ros-out	You may refine your search by editin	g the current search expression or e	ntering a new one	
Tables of Londons	the text box.			
& Magazines  Canterence Proceedings	Then click <b>Search Again</b> .			
	finishing <and> print</and>			
	Search Again	•		
O- Standards				
O- By Author	Results: lournal or Magazine = JNL Conference = CNF Standard = STD			
O-Basic O-Advanced	1 Reliability of lead free s	older joint by using chip si	ze package	
Member Services	Hirano T.: Fukuda, K.: Ito J	C.: Kiga. T.: Taniguchi Y.:		
O- Join IEEE	Hirano, T.; Fukuda, K.; Ito, K.; Kiga, T.; Taniguchi, Y.; Electronics and the Environment, 2001. Proceedings of the 2001 IEEE			
O- Establish IEEE Web Account	International Symposium on	•		
Access the IEEE Member Digital Library	Page(s): 285 -289			
Print Format	[Abstract] [PDF Full-Text (3	864 KB)] <b>IEEE CNF</b>		
	2 Effect of PCR finish on t	he reliability and wettabili	ty of hall	

# 2 Effect of PCB finish on the reliability and wettability of ball grid array packages

Bradley, E.; Banerji, K.;

Electronic Components and Technology Conference, 1995.

Proceedings., 45th , 21-24 May 1995

Page(s): 1028 -1038

## [Abstract] [PDF Full-Text (2472 KB)] **IEEE CNF**

### 3 Simulation case studies in the print/finish industry

Curran, T.; Benjamin, D.M.; Austin, S.;

Simulation Conference Proceedings, 1998. Winter, Volume: 2, 13-16

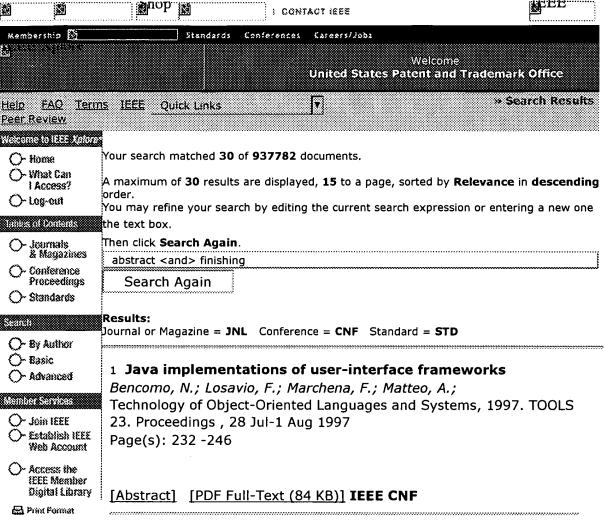
Dec 1998

Page(s): 1501 -1504 vol.2

### [Abstract] [PDF Full-Text (376 KB)] **IEEE CNF**

4 Wetting performance vs. board finish and flux for several





# 2 Implement of system control part in a multimedia communication terminal

Du Wen; Lin Rongrong; Cui Huijuan;

Communication Technology Proceedings, 2000. WCC - ICCT 2000.

International Conference on , Volume: 2 , 2000

Page(s): 1372 -1375 vol.2

### [Abstract] [PDF Full-Text (264 KB)] IEEE CNF

#### 3 Mixed-level VHDL simulation in the real world

Lonsdale, J.K.;

VHDL (Very High Speed Integrated Circuits Hardware Description Language) - Applications and CAE Advances, IEE Colloquium on (Digest No.1993/076), 6 Apr 1993

Page(s): 6/1 -6/3

### [Abstract] [PDF Full-Text (124 KB)] IEE CNF

### 4 Jackson system development

Rollo, A.L.;